Tyrone Camarero Specifications

Camarero SDI200C3R-212

Key Feature

Support CXL

- 5th/4th Gen Intel® Xeon® Scalable processors, Dual Socket LGA-4677 (Socket E), CPU TDP supports up to 350W TDP
- Intel® C741 Chipset
- Up to 4TB 3DS ECC RDIMM, DDR5-5600MT/s in 16 DIMM slots
- 4 PCle 5.0 x16 , 2 PCle 5.0 x8, M.2 Interface: 2 PCle 4.0 x2
- Broadcom BCM57416 Dual ports 10G LAN
- 6 USB3.0 and 3 USB2.0
- 2 SATA DOM ports
- 6 NVMe ports PCle 5.0 x4 via 3 MCIO connectors
- 8 SATA3.0 ports
- 12 x 3.5" hot-swap SAS/SATA drive bay with SES3, optional 2 x 2.5" hot-swap drive bay
- 12-Port 2U Backplane with Expander support up to 8 x 3.5" SAS3/SATA3 HDD/SDD and 4 x SAS3/SATA3/NVMe Storage Devices, HF, RoHS/REACH

Optional chassis: 12Gb/s Direct attached backplane with 3 x Mini-SAS HD Connectors, 1 x Mini-SAS HD connector supports 4 x SAS/SATA

- 920W/1000W/1200W/1600W Redundant power supply
- 3x 8cm high-performance PWM fan(s)





Processor/Cache

Processor

5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors, Dual Socket LGA-4677 (Socket E) supported, CPU TDP supports Up to 350W TDP

System Memory

Memory

16 DIMM slots, Up to 4TB 3DS ECC RDIMM, DDR5-5600MHz

Chipset

Chipset

Intel® C741 Chipset

Expansion Slot

PCI-Express

2 PCle 5.0 x8, 4 PCle 5.0 x16, M.2 Interface: 2

PCIe 4.0 x2

Add-on Options

Raid Card

Optional

Optical Drive None

Front Panel

LEDs Power status LED, HDD activity LED, 2

Network Activity LEDs, Unit Identification (UID) LED, Fan Fail/System Over Heat

LED

Buttons Power On/Off , System Reset button

Drive bays

Drive Bays

Optional 2x2.5" hot-swap drive bay, 12x3.5 hot-swap SAS/SATA drive bay with SES3

Power Supply

Power Supply

920W/1000W/1200W/1600W Redundant power supply

Cooling System

Fans

3x 8cm high-performance PWM fan(s)

Form Factor

Form Factor

2U Rackmount

www.tyronesystems.com

Height -3.5" (89 mm), Width -17.2" (437 mm), Depth -25.5" (647 mm)

Email: Info@tyronesystems.com
For more/current product information, Visit

Intel, the Intel logo, the Intel Inside logo, Xeon, and Intel Xeon Phi are trademarks of Intel Corporation in the U.S and/Or other Countries

Specifications subject to change without notice. Picture used for representation purpose only and the actual product may differ in looks. All other brands and names are the properties of their respective owners